

TOP PANEL


REVERSE FLOW VENTILATION CHAMBER HOUSING FOR 0.039" DIA BEAD THERMISTOR AND RH SENSOR

NOTE: SEE SHEET 3 FOR MOUNTING DETAILS

MATERIAL: 6061-T6 ALUMINUM
FINISH: CLEAR GOLD ANODIZED

RS232 HIROSE CONNECTOR P/N: HR30-6R-6P(71)
CAN / ELECTRONICS POWER HIROSE CONNECTOR P/N: HR30-6R-6S(71)
STATUS LED 2
STATUS LED 1
POWER LED

2 x ANGLE-OF-ATTACK DIFFERENTIAL PRESSURE PORTS
TOTAL (PITOT) PRESSURE PORT
8 x STATIC PRESSURE PORTS
2 x SIDESLIP DIFFERENTIAL PRESSURE PORTS

TITLE AIMMS-20 ADP - UNDERWING MOUNT - TECHNICAL SPECIFICATIONS DRAWING				
DRAWN BY V. MANIVASAKAN	APPROVED BY B. WOODCOCK	DATE ISSUED 11 - 07 - 2013	MATERIAL SEE NOTES	FINISH SEE NOTES
UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES AND METRIC DIMENSIONS IN BRACKETS [] TOLERANCES: TWO PLACE DECIMAL +/- 0.004 THREE PLACE DECIMAL +/- 0.001		THE INFORMATION CONTAINED IN THIS DRAWING IS THE SOLE PROPERTY OF AVENTECH RESEARCH INC.. ANY REPRODUCTION IN PART OR AS A WHOLE WITHOUT THE WRITTEN PERMISSION OF AVENTECH RESEARCH INC. IS PROHIBITED.		
DWG NO. AIMMS20_ADP_UW-TSD			EDITION A	SHEET 1 OF 3